

LA47202P

Specifications

Maximum Ratings at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V_{CC} max1	Without signal, $t = 1$ minute	26	V
	V_{CC} max2	When operating	18	V
Maximum output current	I_O peak	Per channel	4.5	A
Allowable power dissipation	P_d max	With an infinitely large heat sink	50	W
Operating temperature	T_{opr}		-40 to +85	$^\circ\text{C}$
Storage temperature	T_{stg}		-40 to +150	$^\circ\text{C}$
Thermal resistance between junction cases	θ_{j-c}		1	$^\circ\text{C/W}$

Note) The relationship between the power dissipation (P_d) and the junction-to-case thermal resistance (θ_{j-c}), heat sink thermal resistance (θ_f) and junction temperature (T_j), case temperature (T_c), and ambient temperature (T_a) is as expressed by the following equation :

$$T_j = P_d (\theta_{j-c} + \theta_f) + T_a$$

$$= P_d \times \theta_{j-c} + T_c, \quad *T_c = P_d \times \theta_f + T_a$$

Note that T_j max must be limited with T_{stg} max (150°C).

Recommended Operating Ranges at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Recommended supply voltage	V_{CC}		14.4	V
Recommended load resistance	R_L		4	Ω
Operating supply voltage range	V_{CC} op	Range not exceeding P_d max	9 to 16	V

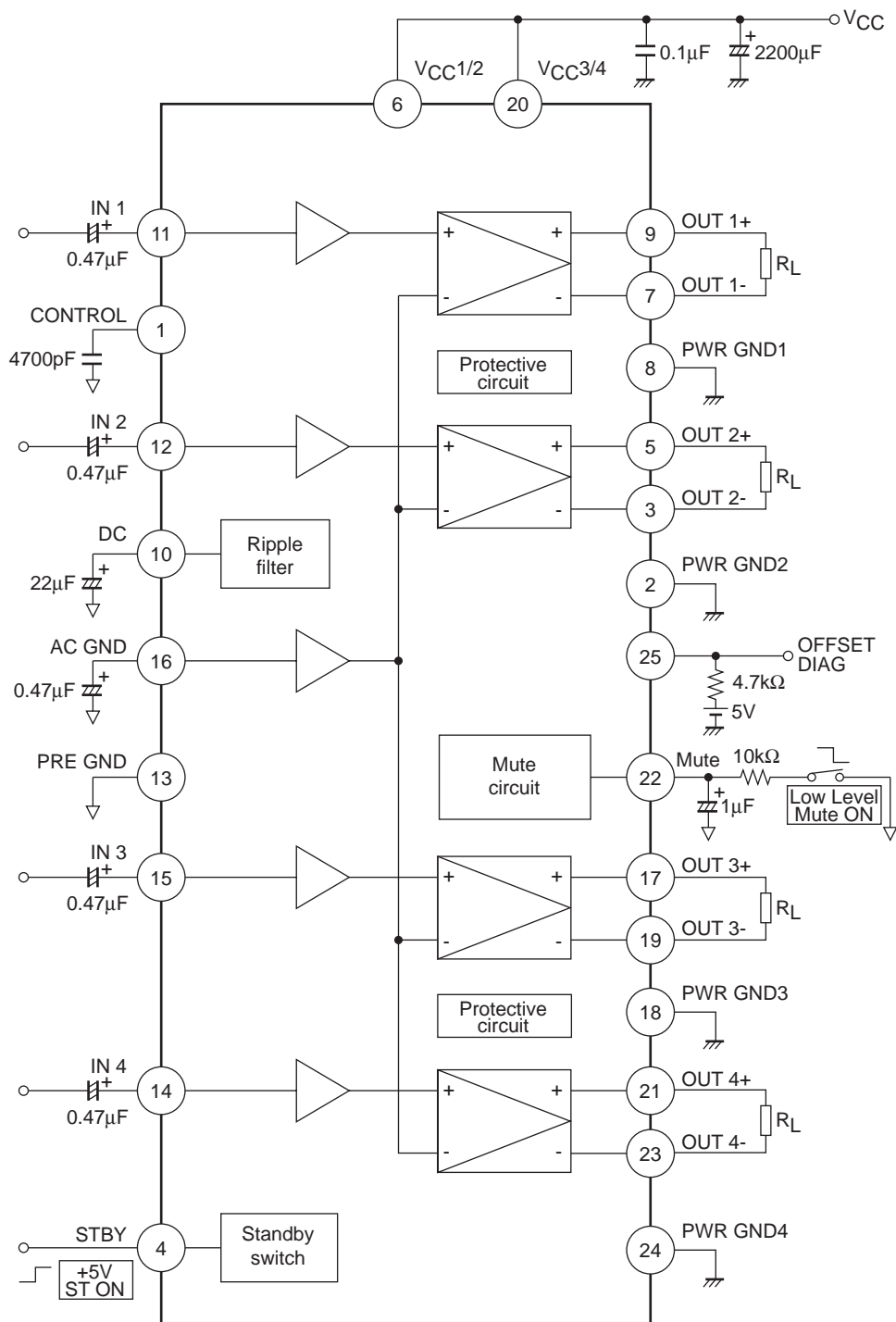
Electrical Characteristics at $T_a = 25^\circ\text{C}$, $V_{CC} = 14.4\text{V}$, $R_L = 4\Omega$, $f = 1\text{kHz}$, $R_g = 600\Omega$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Quiescent current	I_{CCO}	$R_L = \infty$, $R_g = 0$		200	400	mA
Standby current	I_{st}	$V_{st} = 0\text{V}$			10	μA
Voltage gain	VG	$V_O = 0\text{dBm}$	25	26	27	dB
Voltage gain difference	ΔVG		-1		+1	dB
Output power	P_O	THD = 10%	24	29		W
	P_O max1	$V_{CC} = 13.7\text{V}$, JEITA max		42		W
	P_O max2	JEITA max		47		W
Output offset voltage	$V_{noffset}$	$R_g = 0$	-150		+150	mV
Total harmonic distortion	THD	$P_O = 4\text{W}$		0.05	0.3	%
Channel separation	CHsep	$V_O = 0\text{dBm}$, $R_g = 10\text{k}\Omega$	55	65		dB
Ripple rejection ratio	SVRR	$R_g = 0$, $f_r = 100\text{Hz}$, $V_{CCR} = 0\text{dBm}$	45	60		dB
Output noise voltage	V_{NO}	$R_g = 0$, BPF = 20Hz to 20kHz		100	200	μVrms
Input resistance	R_i			50		$\text{k}\Omega$
Mute attenuation	Matt	$V_O = 20\text{dBm}$, mute : on	65	80		dB

* 0dBm = 0.775Vrms

LA47202P

Block Diagram



The components and constant values in the test circuit are used for confirmation of characteristics and do not guarantee that the application equipment will be free from malfunction or trouble.

Description of Operation

1. Standby switch function (pin 4)

The pin 4 threshold voltage is set to about 3 VBE.

The amplifier is turned ON at the application voltage of 3.0V or more and OFF at 0.5V or less.

2. Muting function (pin 22)

When pin 22 is set to the ground potential, the LA47202P goes to the muted state. This supports implementation of an audio muting function.

The muting function is turned on when a level of 1V or lower is applied through a 10kΩ resistor, and the function is turned off when this pin is open.

The muting time constant can be set with an external RC circuit.

3. Self diagnostics function (pin 25)

This function detects abnormal IC states, and outputs a signal from pin 25. Applications can prevent damage to speakers and other problems by using a microcontroller to detect the pin 25 signal and control the standby switch accordingly.

(1) Output short-circuit to V_{CC}/ground : Pin 25 becomes LOW.

(2) Load short-circuit : Pin 25 repeats HIGH and LOW states according to the output signal.

(3) Output offset abnormality : Pin 25 goes low if the OUT pin (V_N) voltage becomes lower than the detection level. Problems that can cause an output offset abnormality include input capacitor leakage and half shorts between the input pins and adjacent circuit components.

Note that pin 25 is the NPN open collector output (active low). Keep pin 25 open-connection when not using.

4. CONTROL pin (pin 1)

The protective circuit response speed is adjusted by the pin 1 capacitor.

By adjusting the response speed of the protective circuit, abnormal sound generated when the protective circuit operates at input of the large signal can be prevented.

When the capacitance value increases, abnormal sound is more difficult to be generated, but the response speed of the protective circuit becomes lower. The capacitance value must be limited to maximum 0.01μF. The recommended value is 4700pF.

Check the optimum value for each set.

As this is designed so that the protective circuit is activated when pin 1 has the GND potential, the protective circuit becomes normally active when the capacitor is short-circuited.

5. AC GND pin (pin 16)

Be sure to use the pin 16 capacitor with the capacity the same as that of the input capacitor and connect it to PREGND the same as that of the input capacitor.

6. Sound quality (low frequencies)

The frequency characteristics in low frequency range may be improved by varying the capacitance of input capacitor.

Note that this may cause influence on the shock noise, carry out confirmation with each set before varying the capacitance value.

7. Impulse noise related systems

While the LA47202P does include an impulse noise prevention circuit, we recommend using the muting function together with this circuit.

- When the amplifier is ON, turn ON the muting function simultaneously with power ON. When the output DC potential has stabilized, turn OFF the muting function.

- When turning OFF the amplifier, first turn ON the muting function, then turn OFF power supply.

8. Oscillation stability

Pay due attention on the following points because parasitic oscillation may occur due to effects of the capacity load, board layout, etc.

(1) Capacity load

When the capacitor is to be inserted between each output pin and GND so as to prevent electric mirror noise, select the capacitance of maximum 1200pF. (Conditions : Our recommended board, $R_L = 4\Omega$)

(2) Board layout

- Provide the V_{CC} capacitor of 0.1 μ F in the position nearest to IC.
- PREGND must be independently wired and connected to the GND point that is as stable as possible, such as the minus pin of the 2200 μ F V_{CC} capacitor.

In case of occurrence of parasitic oscillation, any one of following parts may be added as a countermeasure.

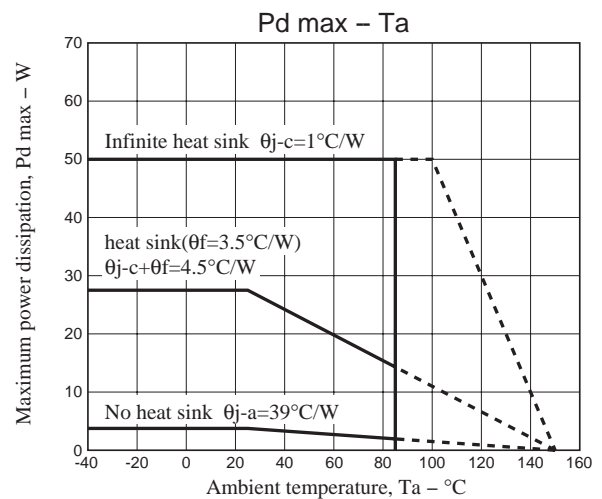
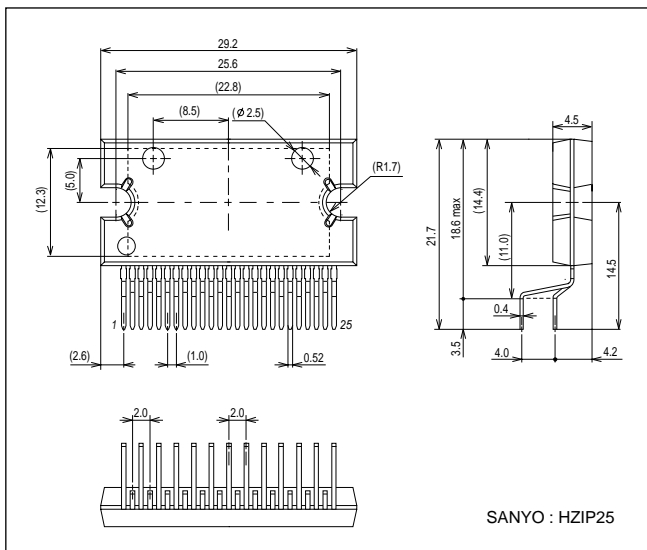
Note that the optimum capacitance must be checked for each set in the mounted state.

- Series connection of CR (0.1 μ F and 2.2 Ω) between BTL outputs
- Series connection of CR (0.1 μ F and 2.2 Ω) between each output pin and GND.

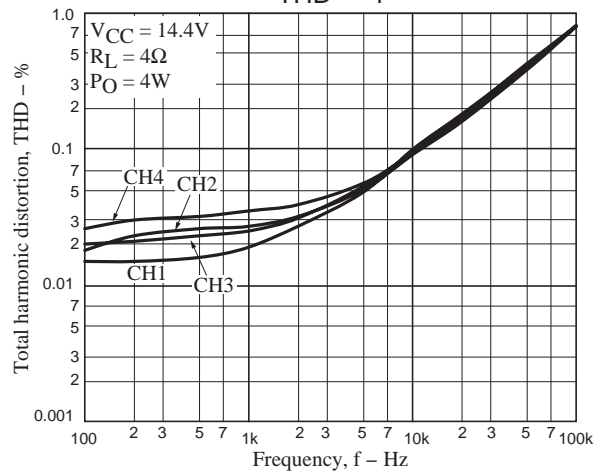
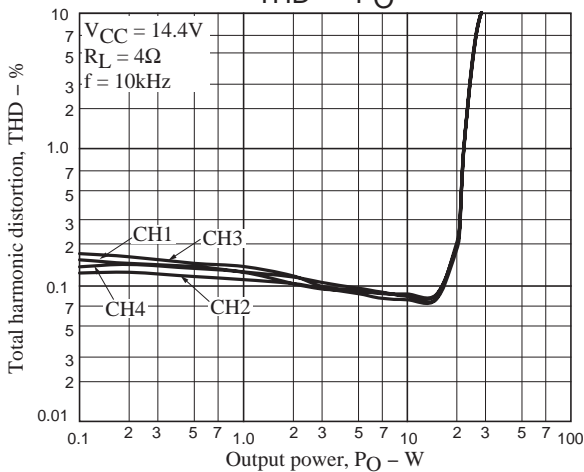
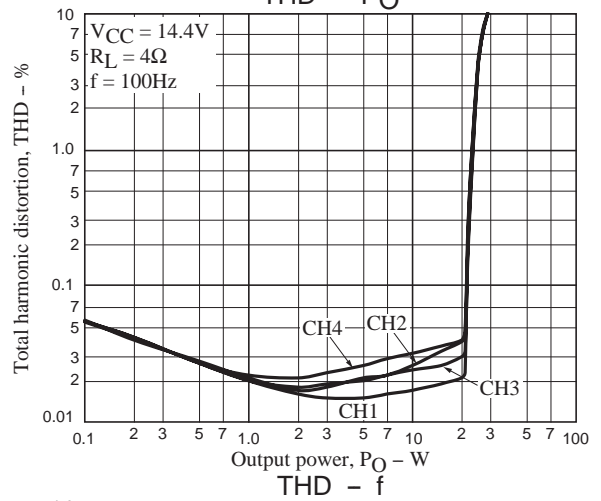
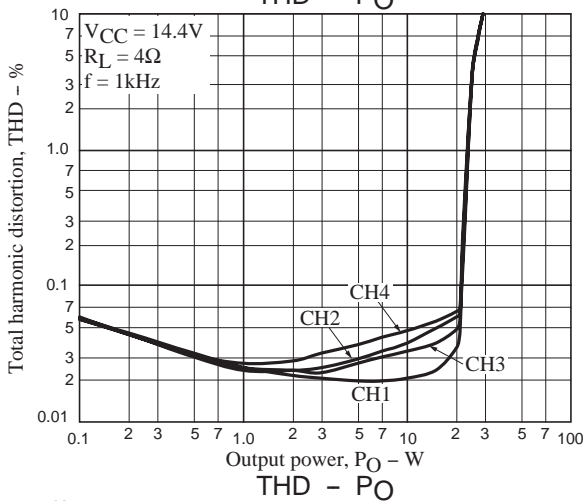
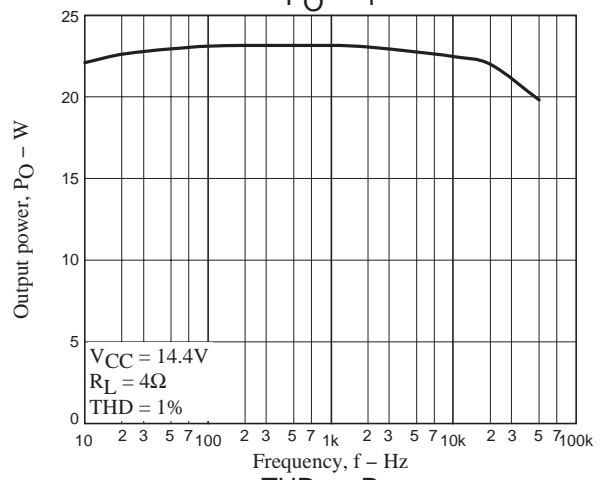
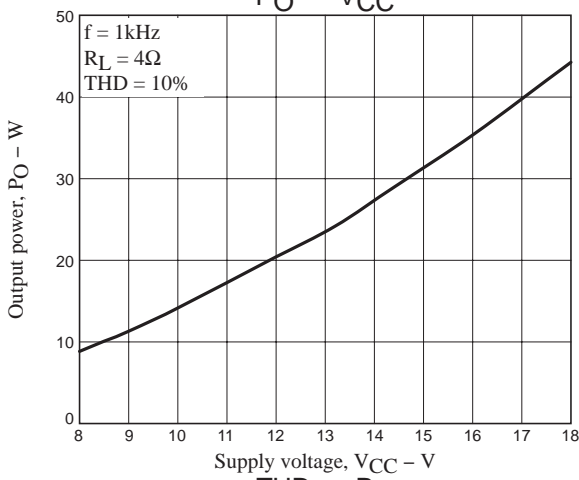
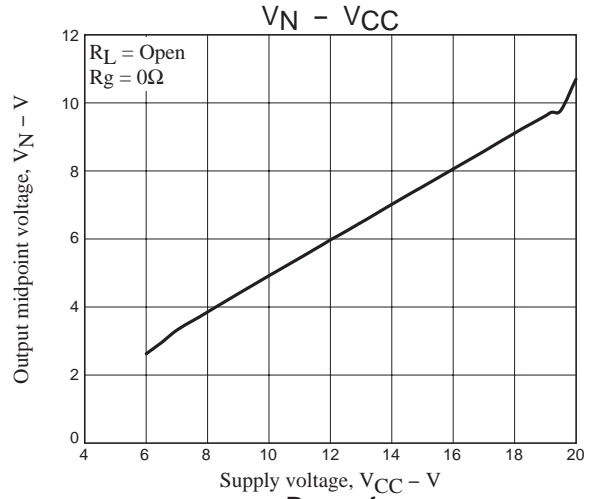
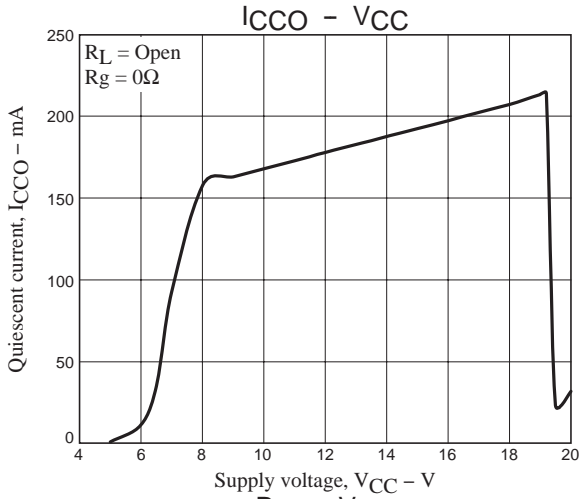
Package Dimensions

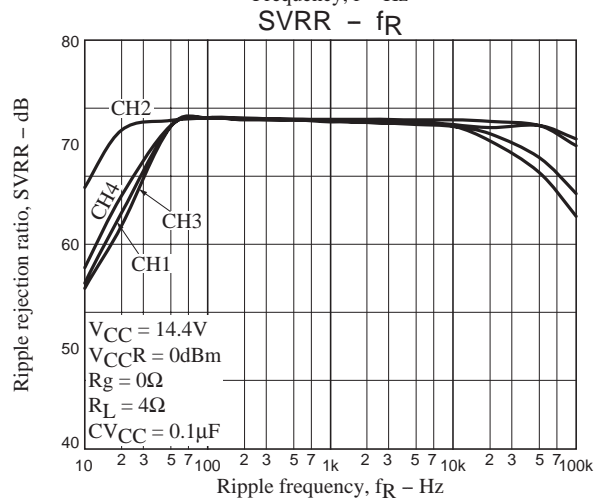
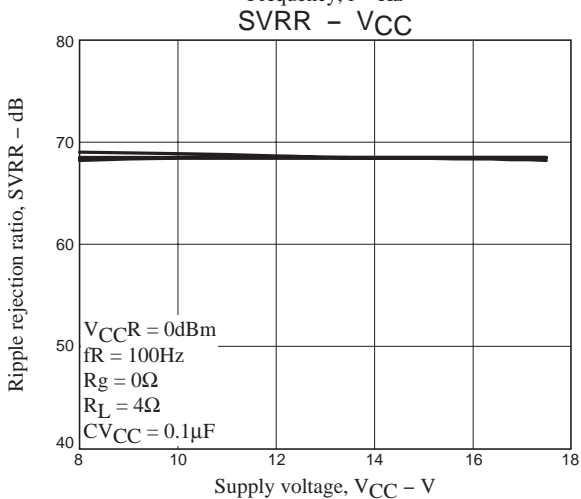
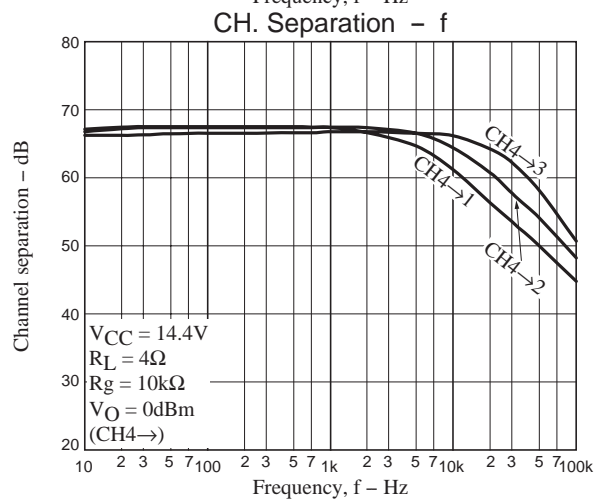
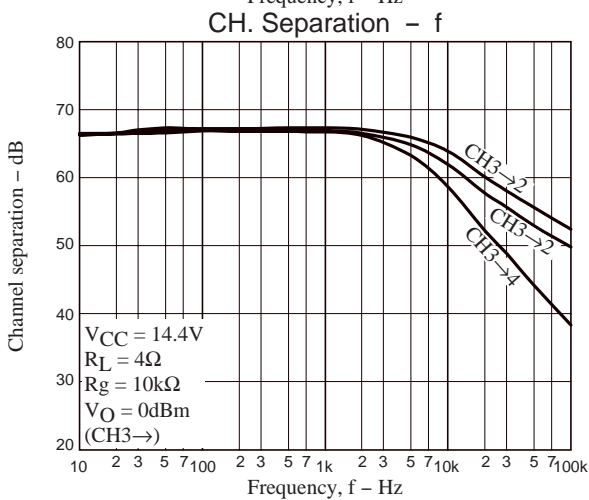
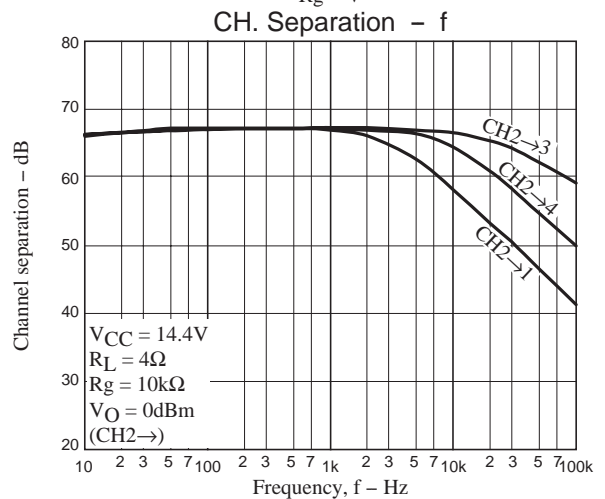
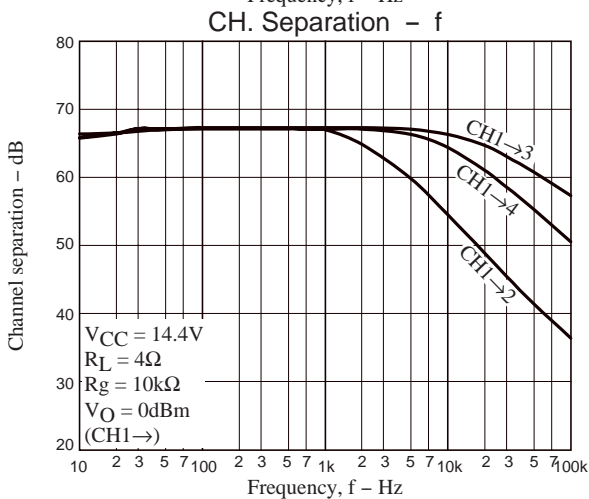
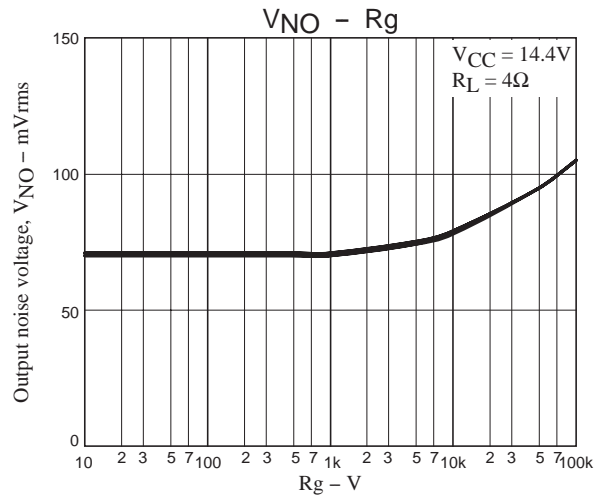
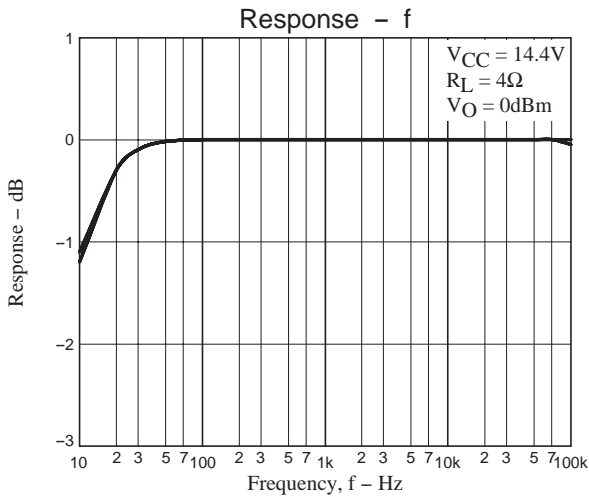
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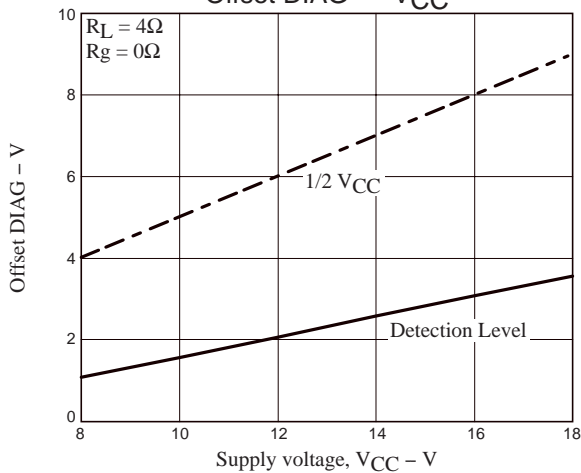
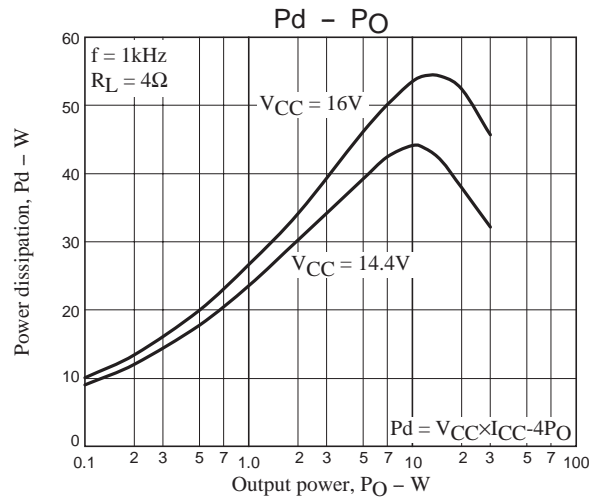
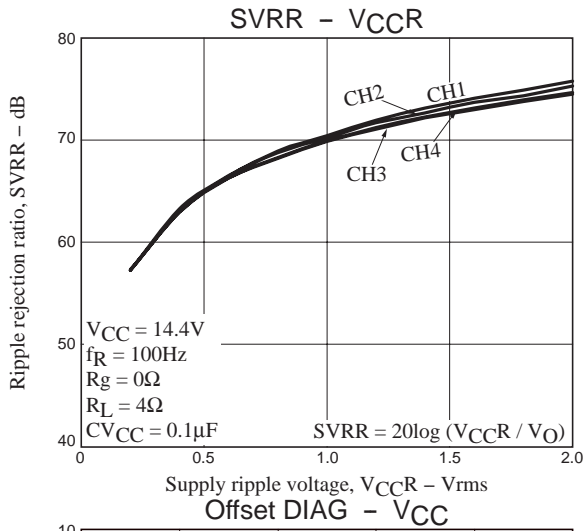
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